

#### **Discription**

Low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode in a ultra-small and flat lead SOD-323 plastic package designed to protect one signal line from the damage caused by ESD and other transients.

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SOD-323

#### **Features**

- ★ Bidirectional ESD protection of one line
- ★ Reverse stand-off voltage: 12.0V Max
- ★ Low leakage current: nA Level
- ★ Response time is typically < 1 ns
- ★ Low clamping voltage: VC < 18 V @ IPP = 18A
- ★ ESD Protection: 30kV(air)/30kV(contact) (IEC61000-4-2)
- ★ RoHS compliant



### **Applications**

- ★ Cell Phone Handsets and Accessories
- ★ Microprocessor based equipment
- ★ Personal Digital Assistants (PDA's)
- ★ Notebooks, Desktops, and Servers

# Circuit Diagram

#### **Ordering Information**

Product ID	Pack	Qty(PCS)
PESD12VL1BA	SOD-323	3000

#### Absolute Ratings(Tamb = 25°C)

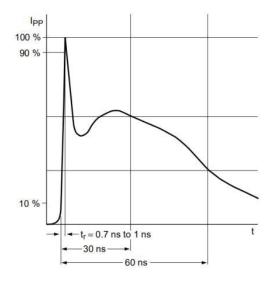
Symbol	Parameter	Value	Units
P <sub>PP</sub>	Peak Pulse Power (t <sub>P</sub> = 8/20 μ s)	340	W
T <sub>L</sub>	Maximum lead temperature for soldering during 10s	260	°C
$T_{stg}$	Storage Temperature Range	-55 to +155	°C
$T_{op}$	Operating Temperature Range	-40 to +125	°C
$T_j$	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD) air discharge		KV
	contact discharge	$\pm 30$	'`'



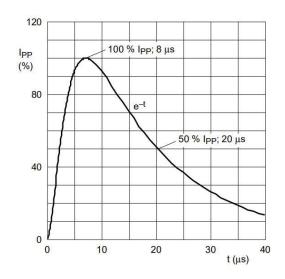
#### **Electrical Characteristics**

Symbol	Parameter	Test Condition	Min Typ		Max	Units
V <sub>RWM</sub>	Reverse Working Voltage				12.0	V
V <sub>BR</sub>	Reverse Breakdown Voltage	Iτ = 1mA	I <sub>T</sub> = 1mA 13.0		15.5	V
IR	Reverse Leakage Current	V <sub>RWM</sub> = 12V			100	nA
Vc Clamping Voltage	Clamping Valtage	$I_{PP} = 10A, t_p = 8/20\mu s$			14.0	V
	Clamping Voltage	$I_{PP} = 18A, t_p = 8/20\mu s$			18.0	V
CJ	Junction Capacitance	$V_R = 0V$ , $f = 1MHz$		15.0	20.0	pF

# **Typical Characteristics**



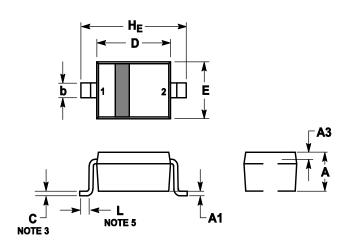
IEC61000-4-2 Waveform



IEC 61000-4-5 Waveform( 8/20µs pulse)



#### **Outline And Dimensions**

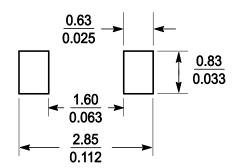


#### Notes:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

	MILLIMETERS		INCHES		3	
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.8	0.9	1	0.031	0.035	0.04
A1	0	0.05	0.1	0	0.002	0.004
A3	0.15REF		0.006REF		F	
b	0.25	0.32	0.4	0.01	0.012	0.016
С	0.089	0.12	0.177	0.003	0.005	0.007
D	1.6	1.7	1.8	0.062	0.066	0.07
Е	1.15	1.25	1.35	0.045	0.049	0.053
L	0.08			0.003		
H <sub>E</sub>	2.3	2.5	2.7	0.09	0.098	0.105

## **Soledering Footprint**



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